


GENESYS™

GH1kW

RELIABILITY

DATA

DWG: IA882-57-01		
APPD	CHK	DWG
<i>Cyami</i> <i>31/05/20</i>	 <i>31.05.2020</i>	Michael Goldsberg 31/05/2020

TDK-LAMBDA

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The above data is typical value. As all units have nearly the same characteristics, the data to be considered as ability value.

M.T.B.F.

Calculation based on parts stress reliability projection of Telcordia (Bellcore)
 "Reliability Prediction Procedure for Electronic Equipment" Document number TR-322, Issue 5)
 Individual failure λ_{SSi} is calculated from electrical stress and temperature rise of each device.

$$MTBF = \frac{1}{\lambda_{equip}} = \frac{1}{\pi_E \sum_{i=1}^m N_i \cdot \lambda_{SSi}} \times 10^9 \quad (\text{hours})$$

$$\lambda_{SSi} = \lambda_{Gi} \cdot \pi_{Qi} \cdot \pi_{Si} \cdot \pi_{Ti}$$

- λ_{equip} : Total Equipment failure rate (FITs = Failures in 10^9 hours)
- λ_{Gi} : Generic failure rate for the i th device
- π_{Qi} : Quality factor for the i th device
- π_{Si} : Stress factor for the i th device
- π_{Ti} : Temperature factor for the i th device
- m : Number of different device types
- N_i : Quantity of i th device type
- π_E : Equipment environmental factor

Conditions:

$T_a = 25^\circ\text{C}$

Gf - Ground, Fixed, Uncontrolled

M.T.B.F. = 665651 (HOURS)

2.COMPONENT DERATING

GH1kW SERIES

Calculation method

(1) Conditions

Input:	Nominal
Output:	Vout - 100%, Iout - 100%
Ambient temperature:	50°C
Mounting Method:	Standard Mounting

(2) Semiconductors

Compared with maximum junction temperature and actual one which is calculated on case temperature, power dissipation and thermal impedance.

(3) IC, Resistors, Capacitors, etc.

Ambient temperature, operating conditions and power dissipation are within derating criteria.

(4) Calculation method of thermal impedance:

$$\Theta_{j-a} = \frac{Tj(\max) - Ta}{Pc(\max)} \quad \Theta_{j-c} = \frac{Tj(\max) - Tc}{Pc(\max)} \quad \Theta_{j-l} = \frac{Tj(\max) - Tl}{Pc(\max)}$$

Tc : Case Temperature at Start Point of Derating; 25°C in General

Ta : Ambient Temperature at Start Point of Derating; 25°C in General

$Pc(\max)$: Maximum Power Dissipation

$Tj(\max)$: Maximum Junction temperature

Θ_{j-c} : Thermal Impedance between Junction and Case

Θ_{j-a} : Thermal Impedance between Junction and Air

Θ_{j-l} : Thermal Impedance between Junction and Lead

Load = 100%

Ta=50°C

INPUT1P

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D1 D25XB60-7000 SHINDENGEN	Tjmax= 150 °C Pd = 5.4 W Tj = Tc + (qj-c x Pd) =>	qj-c = 1.0 °C/W DTc = 52.2 °C Tj = 107.6 °C	Pmax = --- W Tc = 102.2 °C D.F. = 71.7 %
A4 TPS54202DDCR TI	Tjmax= 150 °C Pd = 0.31 W Tj = Tc + (qj-c x Pd) =>	qj-c = 39.5 °C/W DTc = 8.7 °C Tj = 70.9 °C	Pmax = --- W Tc = 58.7 °C D.F. = 47.3 %
A5 TPS54202DDCR TI	Tjmax= 150 °C Pd = 0.03 W Tj = Tc + (qj-c x Pd) =>	qj-c = 39.5 °C/W DTc = 8.7 °C Tj = 59.9 °C	Pmax = --- W Tc = 58.7 °C D.F. = 39.9 %
A6 MIP2E5DMY PANASONIC	Tjmax= 150 °C Pd = 1.85 W Tj = Tc + (qj-c x Pd) =>	qj-c = 3.0 °C/W DTc = 8.8 °C Tj = 64.4 °C	Pmax = --- W Tc = 58.8 °C D.F. = 42.9 %
A7 TPS560200DBVR TI	Tjmax= 125 °C Pd = 0.1 W Tj = Tc + (qj-c x Pd) =>	qj-c = 100 °C/W DTc = 8.7 °C Tj = 68.7 °C	Pmax = --- W Tc = 58.7 °C D.F. = 55.0 %

Load = 100%

Ta=50°C

PFC

Q3 TK39N60W,S1VF Toshiba	Tjmax= 150 °C Pd = 5.22 W Tj = Tc + (qj-c x Pd) =>	qj-c = 0.5 °C/W DTc = 29.3 °C Tj = 81.7 °C	Pmax = 270.0 W Tc = 79.3 °C D.F. = 54.5 %
Q4 TK39N60W,S1VF Toshiba	Tjmax= 150 °C Pd = 5.22 W Tj = Tc + (qj-c x Pd) =>	qj-c = 0.5 °C/W DTc = 29.3 °C Tj = 81.7 °C	Pmax = 270.0 W Tc = 79.3 °C D.F. = 54.5 %
D3 IDH10G65C5 INFINEON	Tjmax= 175 °C Pd = 4.6 W Tj = Tc + (qj-c x Pd) =>	qj-c = 1.7 °C/W DTc = 41.0 °C Tj = 98.8 °C	Pmax = 89.0 W Tc = 91.0 °C D.F. = 56.4 %

Load = 100%

Ta=50°C

DC/DC 10V

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Q1 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 13.2 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 28.5 °C Tj = 86.0 °C	Pmax = 220.0 W Tc = 78.5 °C D.F. = 57.3 %
Q2 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 13.2 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 28.5 °C Tj = 86.0 °C	Pmax = 220.0 W Tc = 78.5 °C D.F. = 57.3 %
Q23-Q27 IPP023N04N G Infineon	Tjmax= 175 °C Pd = 0.65 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.9 °C/W DTc = 19.7 °C Tj = 70.3 °C	Pmax = 167.0 W Tc = 69.7 °C D.F. = 40.2 %

Load = 100%

Ta=50°C

DC/DC 150V

Q1 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 13.2 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 27.9 °C Tj = 85.4 °C	Pmax = 220.0 W Tc = 77.9 °C D.F. = 56.9 %
Q2 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 13.2 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 27.9 °C Tj = 85.4 °C	Pmax = 220.0 W Tc = 77.9 °C D.F. = 56.9 %
D31-D36 YG911S3R Fuji	Tjmax= 150 °C Pd = 3.5 W Tj = Tc + (q j-c x Pd) =>	qj-c = 3.5 °C/W DTc = 29.6 °C Tj = 91.9 °C	Pmax = --- W Tc = 79.6 °C D.F. = 61.2 %

Load = 100%


Ta=50°C

DC/DC 600V

Q1 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 13.4 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 27.9 °C Tj = 85.5 °C	Pmax = 220.0 W Tc = 77.9 °C D.F. = 57.0 %
Q2 FMW30N60S1HF Fuji	Tjmax= 150 °C Pd = 11.2 W Tj = Tc + (q j-c x Pd) =>	qj-c = 0.57 °C/W DTc = 27.9 °C Tj = 84.3 °C	Pmax = 220.0 W Tc = 77.9 °C D.F. = 56.2 %
D31-D36 IDH02SG120 Infineon	Tjmax= 175 °C Pd = 3.41 W Tj = Tc + (q j-c x Pd) =>	qj-c = 2.0 °C/W DTc = 29.6 °C Tj = 86.4 °C	Pmax = --- W Tc = 79.6 °C D.F. = 49.4 %


3.Main Components Temperature Rise

GH10-100

Location No.		Parts Name	ΔT Temperature Rise (°C)
			Standard Mounting
DC-DC	A3	Gate Driver	30.4
	C8	EL. Capacitor	23.3
	R99	Shunt Resistor	31.3
	Q2	Buck Mosfet	28.5
	Q27	Mosfet Rectifier	20.2
PFC	L1	Choke	52.4
	D3	Diode	48.0
	Q3	Mosfet	34.4
	C24	E-Cap	9.6
OUTPUT FILTER	C1	E-Cap	22.9
INPUT	D1	Bridge	53.8
	RL1	Relay	22.0
	A6	Top-Switch	7.9
	T1	Transformer	12.4
	C28	E-Cap	4.3
	C45	E-Cap	10.6
	C66	E-Cap	6.3
	C76	E-Cap	9.9
Conditions:			
Standard Mounting			
Input Voltage		85V~265V	
Output Voltage		10V	
Output Current		100A	


3.Main Components Temperature Rise

GH150-7

Location No.		Parts Name	ΔT Temperature Rise (°C)
			Standard Mounting
DC-DC	Q2	Buck Mosfet	30.6
	D32	Diode Rectifier	33.0
	R99	Shunt Resistor	23.9
	C5	E-Cap	22.5
OUTPUT FILTER	C15	E-Cap	69.8
Conditions:			
Standard Mounting			
Ta		50°C	
Input Voltage		85V~265V	
Output Voltage		150V	
Output Current		7A	

3.Main Components Temperature Rise

GH600-1.7

Location No.		Parts Name	ΔT Temperature Rise (°C)
			Standard Mounting
DC-DC	Q2	Buck Mosfet	26.4
	D32	Diode Rectifier	22.3
	R99	Shunt Resistor	18.5
	C5	E-Cap	18.7
OUTPUT FILTER	C15	E-Cap	21.1
Conditions:			
Standard Mounting			
Ta		50°C	
Input Voltage		85V~265V	
Output Voltage		600V	
Output Current		1.7A	

4.ELECTROLYTIC CAPACITORS LIFE TIME ESTIMATION


MODEL	COMPUTED LIFE (year) at Tambient		
	30°C	40°C	50°C
G10V-170A	15	15	7.6
G60V-28A	15	15	7.6
G150V-11.2A	15	15	7.6
G600V-2.8A	15	15	7.6

FORMULA $L = L_o \times 2^{\frac{105-T_c}{10}}$ (years)

L: Elec.capacitor computed life (24 hours per day,365 days operation)

L_o: Guarantee life for Elec.capacitor

T_c: Case temperature of Elec.capacitor

Standard Mounting	
Input Voltage	Nom.
Output Voltage	100%
Output Current	100%

5. ABNORMAL TEST

INPUT 1P

Condition: Ta:25°C Input:230VAC Vout:100% Iout:100%

No.	Test Position		Failure	Study result (prediction of the phenomena)														Note			
	Location No.	Test Point		Short	Open	Fire	Slight Smoke	Smoke	Burst	Smell	Red Hot	Damaged	Fuse Open	P < O	P C O	P T O	AC FAIL		No Output	No Change	PS functional after AC recycle
1	A4	2-3	●														●				Input-A4
2	A5	2-3	●														●				Input-A5
3	A6	1-2	●														●		●		Display stopped working
4		1		●													●		●		Display stopped working
5		2-3	●														●				Input-F3
6		2		●													●		●		Display stopped working
7		3-1	●														●				Input-F3;ZD4;A6
8		3		●													●		●		Display stopped working
9	A7	3-4	●														●			●	Input-A7,Internal Error
10	C28		●														●		●		Display stopped working
11				●															●		
12	C50	thermal:A5,L4	●														●		●	●	Internal Error. Input-A5&L4-35°C
13				●															●		
14	C70	thermal:A8,L6	●																		● Fan's stopped working*
15				●															●		
16	D1	4		●													●		●		
17	D7	A-C	●														●				Input-A5
18		A		●															●		
19	D9	A-C	●														●		●	●	Internal Error
20		A		●															●		
21	D14	A-C	●														●		●		Display stopped working
22	D17	A-C	●														●		●		Display stopped working
23		A		●															●		

5. ABNORMAL TEST

PFC 1P

Condition: Ta:25°C Input:230VAC Vout:100% Iout:100%

No.	Test Position		Failure	Study result (prediction of the phenomena)													Note					
	Location No.	Test Point		Short	Open	Fire	Sligh Smoke	Smoke	Burst	Smell	Red Hot	Damaged	Fuse Open	P < O	P O O	P T O		AC FAIL	No Output	No Change	PS functional after AC recycle	Others
1	C20;24;25		●									●					●					Input F1, F2
2				●														●				
3	D3	A-C	●									●	●				●					Input F1, F2;PFC Q4
4		A		●								●	●				●					Input F1, F2;PFC Q3
5	L1		●														●		●	●		Input Relay Clicking
6				●													●		●	●		Display shows: V - 0 and I - 0
7	Q1	B-E	●															●				
8		B		●								●	●				●					Input F1, F2;PFC Q3
9		K-E	●									●	●				●			●		Display shows: V - 0 and I - 0 ;PFC R13
10		E		●								●	●				●					Input F1, F2;PFC Q3
11		K-B	●									●	●				●		●	●		Display shows: V - 0 and I - 0
12		K		●								●	●					●				Input F2;PFC Q4
13	Q2	B-E	●															●				
14		B		●								●	●				●					After 2 min. Input F1, F2;PFC Q3
15		K-E	●									●	●								●	PFC R13 (P.S. continued to work)
16		E		●								●	●				●					Input F1, F2;PFC Q4
17		K-B	●									●	●				●					Input F1, F2;PFC Q4
18		K		●														●				
19	Q3	G-S	●									●	●				●			●		Output 4min. Not stable;PFC R13
20		G		●								●	●				●					Input F1, F2;PFC Q3
21		D-S	●									●	●				●					Input F1, F2
22		S		●																	●	PFC Q4 temp enlarge from 42°C to 46°C
23		D-G	●									●	●				●					Input F1, F2;PFC Q3
24		D		●																	●	PFC Q4 temp enlarge from 42°C to 46°C

5. ABNORMAL TEST

DCDC 10V

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Condition: Ta:25°C Input:230VAC Vout:100% Iout:100%

No.	Test Position		Failure	Study result (prediction of the phenomena)														Note			
	Location No.	Test Point		Short	Open	Fire	Slight Smoke	Smoke	Burst	Smell	Red Hot	Damaged	Fuse Open	P < O	P O	P T O	AC FAIL		No Output	No Change	PS functional after AC recycle
1	C8		•						•		•	•						•			A1, Q2, Q6-Q10, D11, D13, D14, ZD1, R6, R39, R40, R41, R42
2				•														•			
3	C17		•															•			PFC3P200 - D1; Input3P200 - F1, F3
4				•														•			
5	L3		•															•			
6				•														•			
7	Q1	G-S	•															•		•	Q2 temp enlarge from 57°C to 76°C
8		G		•										•				•		•	
9		D-S	•											•				•		•	
10		S		•														•		•	Q2 temp enlarge from 57°C to 76°C
11		D-G	•											•				•		•	
12		D		•														•		•	Q2 temp enlarge from 57°C to 76°C
13	Q5	G-S	•															•		•	Vo go down to 6V; Mode CV change to CC
14		G		•					•		•	•						•			A1, Q6, Q5, C12, C14, C20, Q1, D1, R2, ZD1, R5
15		D-S	•						•		•	•						•			A1, Q6, Q5, Q1, D1, R1, R2, ZD1, R5
16		S		•														•		•	Vo go down to 6V; Mode CV change to CC
17		D-G	•						•		•	•						•			A1, Q5, Q6, Q4, Q1, D1, D6, D8, R1, R2, ZD1, R5, R27, R28,
18		D		•														•		•	Vo go down to 6V; Mode CV change to CC
19	Q23	G-S	•															•			
20		G		•														•		•	
21		D-S	•						•		•	•						•			A1, Q25, Q5-Q7, Q9, Q1, D1, D6, R2, ZD1, R5, R27, R30, R39
22		S		•														•		•	
23		D-G	•						•		•	•						•			A1, Q22, Q23, Q25, Q5-Q7, Q9, Q1, D1, D6, R2, ZD1, R5, R27, R30, R39, R84
24		D		•														•			
25	T3	1-2	•						•		•	•						•			A1, Q5, Q9, Q10, Q7, C12, C14, C20, Q1, D1, D6, R2, ZD1, R5, R39
26		1		•														•		•	
27		A-C	•								•							•			A1, Q17, Q25, Q1, Q2, Q5-Q7, Q9, D1, D6, ZD1, R5, R6, R27, R30, R39
28		A		•														•		•	Vo go down to 6V
29		B-C	•								•							•			A1, Q17, Q25, Q1, Q2, Q5-Q7, Q9, D1, D6, ZD1, R5, R6, R27, R30, R39
30		B		•														•		•	Vo go down to 6V

